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Part Number:

0878320810

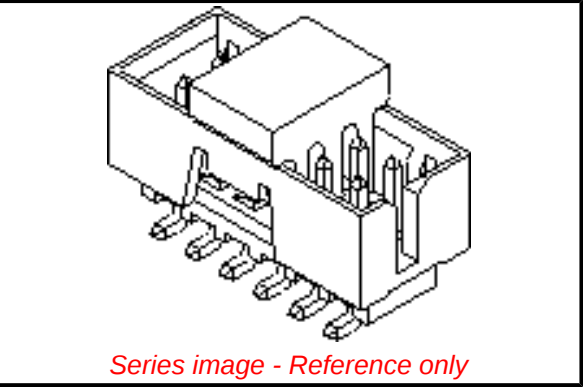
Status:

Active

Overview:

Description:

2.00mm (.079") Pitch Milli-Grid™ Header, Surface Mount, Vertical, Shrouded, Lead-free, 8 Circuits, 0.38µm (15µ") Gold (Au) Plating, with Locking Window, without Cap, PCB Locator, Tube



Documents:	
3D Model	Product Specification PS-87831-027 (PDF)
Drawing (PDF)	RoHS Certificate of Compliance (PDF)

General	
Product Family	PCB Headers
Series	87832
Application	Wire-to-Board
Comments	Contact Molex for application in automotive industry
Overview	Milli-Grid™
Product Name	Milli-Grid™
Physical	
Breakaway	No
Circuits (Loaded)	8
Circuits (maximum)	8
Color - Resin	Black
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Compliant	No
Guide to Mating Part	No
Keying to Mating Part	Yes
Lock to Mating Part	Yes
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Nylon
Number of Rows	2
Orientation	Vertical
PCB Locator	Yes
PCB Retention	None
Packaging Type	Tube
Pitch - Mating Interface (in)	0.079 In
Pitch - Mating Interface (mm)	2.00 mm
Pitch - Term. Interface (in)	0.079 In
Pitch - Term. Interface (mm)	2.00 mm
Plating min: Mating (µin)	15
Plating min: Mating (µm)	0.38
Plating min: Termination (µin)	75
Plating min: Termination (µm)	1.88
Polarized to Mating Part	Side Slots (2)
Polarized to PCB	No
Shrouded	Fully
Stackable	No
Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Surface Mount
Electrical	
CSA	LR19980
Current - Maximum	2A

EU RoHS

ELV and RoHS

Compliant

REACH SVHC

Contains SVHC: No

Halogen-Free

Status

Not Reviewed

China RoHS

Need more information on product environmental compliance?

Email productcompliance@molex.com

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

87832 Series

Mates With

50394 Wire-to-Board Terminals. 51110 Wire-to-Board Crimp Housing. 87568 Wire-to-Board IDT Housings. 79107 Board-to-Board Top Entry Through Hole Receptacle. 79108 Board-to-Board FFC/FPC Top Entry Through Hole Receptacle. L

UL	E29179
Voltage - Maximum	125V

Solder Process Data

Duration at Max. Process Temperature (seconds)	10
Lead-free Process Capability	Reflow Capable (SMT only)
Max. Cycles at Max. Process Temperature	1
Process Temperature max. C	260

Material Info

Reference - Drawing Numbers

Product Specification	PS-87831-027
Sales Drawing	SD-87832-010

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